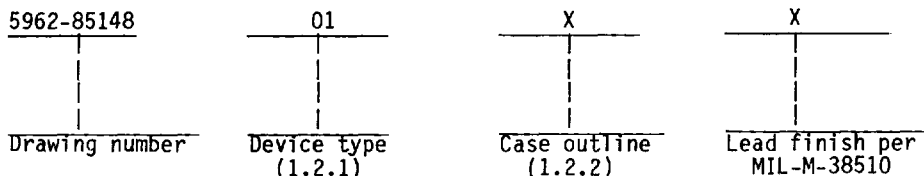


1. SCOPE

1.1 Scope. This drawing describes device requirements for class B microcircuits in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices".

1.2 Part number. The complete part number shall be as shown in the following example:



1.2.1 Device types. The device types shall identify the circuit function as follows:

<u>Device type</u>	<u>Generic number</u>	<u>Frequency</u>	<u>Circuit function</u>
01	M80286-8	8 MHz	16-bit microprocessor
02	M80286-6	6 MHz	16-bit microprocessor
03	M80286-10	10 MHz	16-bit microprocessor

1.2.2 Case outlines. The case outlines shall be as designated in appendix C of MIL-M-38510, and as follows:

<u>Outline letter</u>	<u>Case outline</u>
X	P-AC 68-terminal (1.160" by 1.160") pin grid array
Y	68-terminal ceramic quad package (see figure 3)

1.3 Absolute maximum ratings.

Supply voltage range with respect to ground (V_{CC})	-1.0 to +7.0 V dc
Storage temperature range	-65°C to +150°C
Maximum power dissipation (P_D) (per device type)	3.3 W dc
Lead temperature (soldering, 5 seconds)	+300°C
Junction temperature (T_J)	+200°C
Thermal resistance, junction-to-case (θ_{JC})	+9.5°C/W

1.4 Recommended operating conditions.

Supply voltage (V_{CC})	4.75 V dc minimum to 5.25 V dc maximum
Minimum high level input voltage (V_{IH}):	
Logic inputs	2.0 V dc to $V_{CC} + .5$ V dc
Clock input	3.8 V dc to $V_{CC} + .5$ V dc
Maximum low level input voltage (V_{IL}):	
Logic inputs	-0.5 V dc to 0.8 V dc
Clock input	-0.5 V dc to 0.6 V dc
Minimum high level output voltage	2.4 V dc
Maximum low level output voltage	0.45 V dc
Frequency of operation:	
01	8 MHz
02	6 MHz
03	10 MHz
Case operating temperature range	-55°C to +125°C

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 67268	DWG NO. 5962-85148
	REV A		PAGE 2

2. APPLICABLE DOCUMENTS

2.1 Government specification and standard. Unless otherwise specified, the following specification and standard, of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

SPECIFICATION

MILITARY

MIL-M-38510 - Microcircuits, General Specification for.

STANDARD

MILITARY

MIL-STD-883 - Test Methods and Procedures for Microelectronics.

(Copies of the specification and standard required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.

3.2.1 Terminal connections. The terminal connections shall be as specified on figure 1.

3.2.2 Block diagram. The block diagram shall be as specified on figure 2.

3.2.3 Case outlines. The case outlines shall be in accordance with 1.2.2 and figure 3.

3.3 Electrical performance characteristics. Unless otherwise specified, the electrical performance characteristics are as specified in table I and apply over the full recommended case operating temperature range.

3.4 Marking. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with the part number listed in 1.2 herein. In addition, the manufacturer's part number may also be marked as listed in 6.5 herein.

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 67268	DWG NO. 5962-85148
		REV A	PAGE 3

TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions -55°C < T _C < +125°C unless otherwise specified V _{CC} = 5.0 V ±5%	Device type	Group A subgroups	Limits		Unit
					Min	Max	
Input low voltage	V _{IL}		A11	1, 2, 3	-0.5	0.8	V
Input high voltage	V _{IH}		A11	1, 2, 3	2.0	V _{CC} + 0.5	V
CLK input low voltage	V _{ILC}		A11	1, 2, 3	-0.5	0.6	V
CLK input high voltage	V _{IHC}		A11	1, 2, 3	3.8	V _{CC} + 0.5	V
Output low voltage	V _{OL}	I _{OL} = 2.0 mA	A11	1, 2, 3		0.45	V
Output high voltage	V _{OH}	I _{OH} = -400 μA	A11	1, 2, 3	2.4		V
Input leakage current	I _{LI}	0 V ≤ V _{IN} ≤ V _{CC}	A11	1, 2, 3		±10	μA
Input sustaining current on BUSY and ERROR pins	I _{IL}	V _{IN} = 0 V	A11	1, 2, 3	30	500	μA
Output leakage current	I _{LO1}	0.45 V ≤ V _{OUT} ≤ V _{CC}	A11	1, 2, 3		±20	μA
Output leakage current <u>1/</u>	I _{LO2}	0 V ≤ V _{OUT} ≤ 0.45 V	A11	1, 2, 3		±1	mA
Supply current <u>2/</u>	I _{CC}		A11	1, 2, 3		600	mA
CLK input capacitance	C _{CLK}	F _C = 1 MHz See 4.3.1c	A11	4		20	pF
Other input capacitance	C _{IN}	F _C = 1 MHz See 4.3.1c	A11	4		10	pF
Input/Output capacitance	C _O	F _C = 1 MHz See 4.3.1c	A11	4		20	pF

See footnotes at end of table.

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 67268	DWG NO. 5962-85148
		REV A	PAGE 4

TABLE I. Electrical performance characteristics - Continued.

Test	Waveform reference	Conditions -55°C < T _C < +125°C unless otherwise specified V _{CC} = 5.0 V ±5%	Device type	Group A subgroups	Limits		Unit
					Min	Max	
System clock period	1		01	9, 10, 11	1/62	250	ns
			02		83	250	
			03		50	250	
System clock low time	2	@ 1.0 V	01	9, 10, 11	1/15	225	ns
			02		20	225	
			03		12	234	
System clock high time	3	@ 3.6 V	01	9, 10, 11	1/25	1/235	ns
			02		1/25	230	
			03		1/16	238	
System clock ^{1/} rise time		1.0 V to 3.6 V	01, 02	9, 10, 11		10	ns
			03			8	
System clock ^{1/} fall time		3.6 V to 1.0 V	01, 02	9, 10, 11		10	ns
			03			8	
Asynchronous input setup time ^{4/}	4		01, 03	9, 10, 11	20		ns
			02		30		
Asynchronous input hold time ^{5/}	5		01, 03	9, 10, 11	20		ns
			02		30		
RESET setup time	6		01	9, 10, 11	28		ns
			02		33		
			03		23		
RESET hold time	7		A11	9, 10, 11	5		ns
Read data setup time	8		01	9, 10, 11	10		ns
			02		20		
			03		8		

See footnotes at end of table.

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 67268	DWG NO. 5962-85148
		REV A	PAGE 5

TABLE I. Electrical performance characteristics - Continued.

Test	3/ Wave- form refer- ence	Conditions -55°C < T _C < +125°C unless otherwise specified V _{CC} = 5.0 V ±5%	Device type	Group A subgroups	Limits		Unit
					Min	Max	
Read data hold time	9		A11	9, 10, 11	8		ns
$\overline{\text{Ready}}$ setup time	10		01	9, 10, 11	38		ns
			02		50		
			03		26		
$\overline{\text{Ready}}$ hold time	11		01, 03	9, 10, 11	25		ns
			02		35		
Status/ $\overline{\text{PEACK}}$ valid delay	12	5/, 6/	01	9, 10, 11	1	40	ns
			02		1	55	
			03		1	22	
Address valid delay	13	5/, 6/	01	9, 10, 11	1	60	ns
			02		1	80	
			03		1	47	
Write data valid delay	14	5/, 6/	01	9, 10, 11	1/ 0	50	ns
			02		1/ 0	65	
			03		0	40	
Address/status/data float delay	15	5/, 7/	01	9, 10, 11	0	50	ns
			02		0	80	
			03		0	47	
HLDA valid delay	16	5/, 6/	01	9, 10, 11	0	50	ns
			02		0	80	
			03		0	47	

1/ Guaranteed if not tested.

2/ Low temperature is worst case.

3/ See figure 4.

4/ Asynchronous inputs are INTR, NMI, HOLD, PREQ, $\overline{\text{ERROR}}$, and $\overline{\text{BUSY}}$. This specification is given only for testing purposes to assure recognition at a specific CLK edge.

5/ Delay from 0.8 V on the CLK to 0.8 V or 2.0 V or float on the output as appropriate for valid or floating condition.

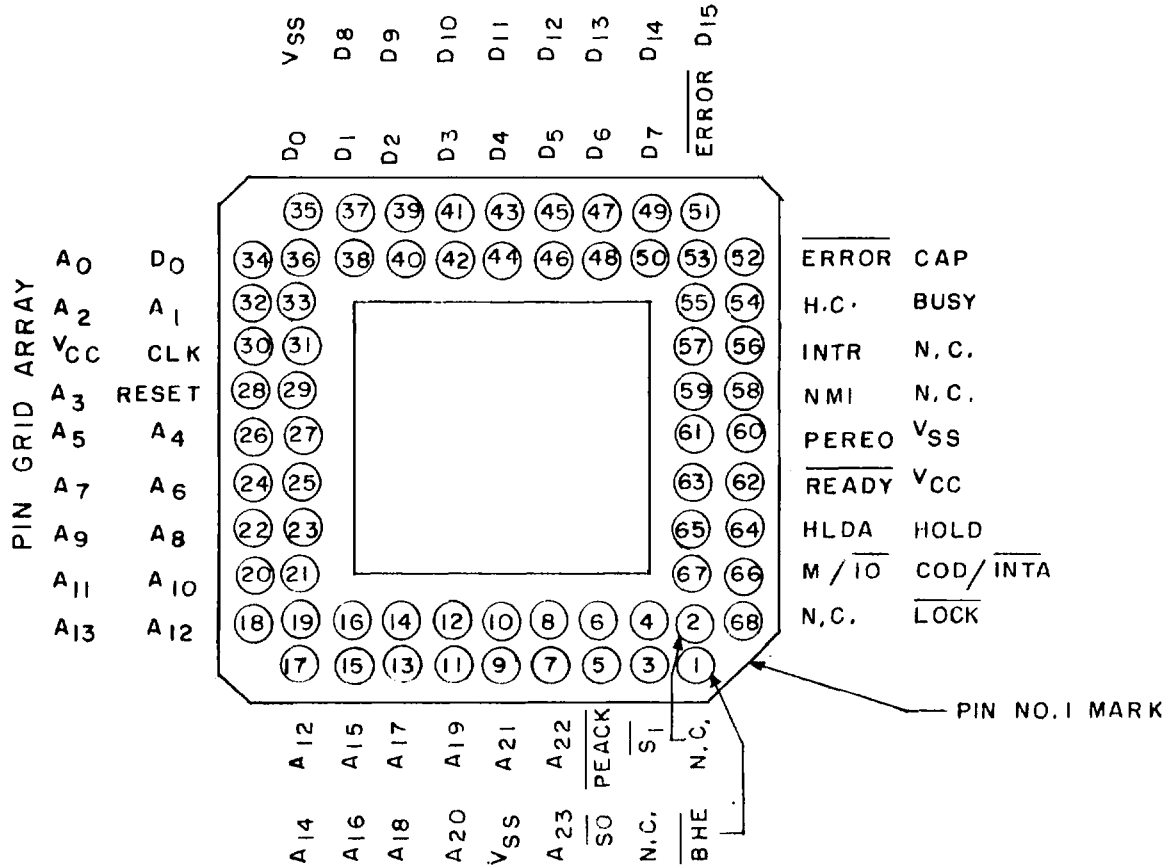
6/ Output load: C_L = 100 pF.

7/ Float condition occurs when output current is less than I_{LO} in magnitude.

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE	CODE IDENT. NO.	DWG NO.
	A	67268	5962-85148
	REV	A	PAGE 6

Case X

Component pad view -- As viewed from underside of component when mounted on the board.



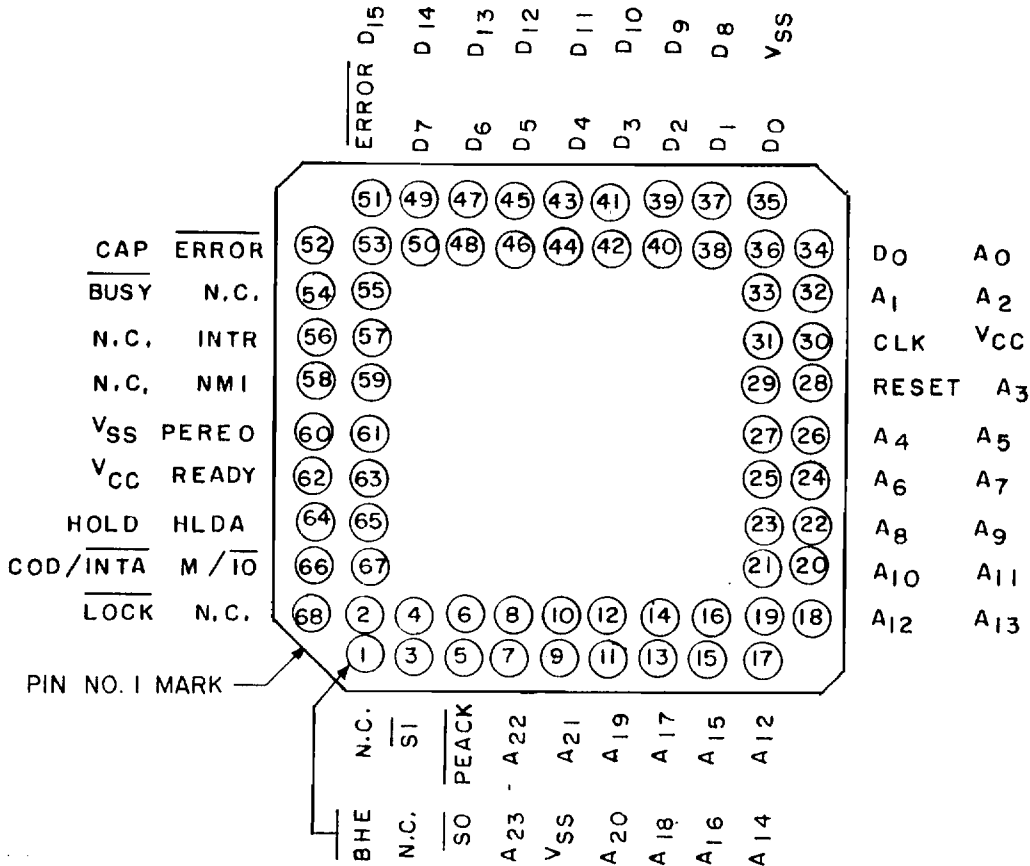
NOTE: N.C. signals must not be connected.

FIGURE 1. Terminal connections.

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 67268	DWG NO. 5962-85148
		REV A	PAGE 7

Case X

P.C. Board View -- As viewed
from the component side of
the P.C. board.



NOTE: N.C. signals must not be connected.

FIGURE 1. Terminal connections - Continued.

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 67268	DWG NO. 5962-85148
		REV A	PAGE 8

Case Y

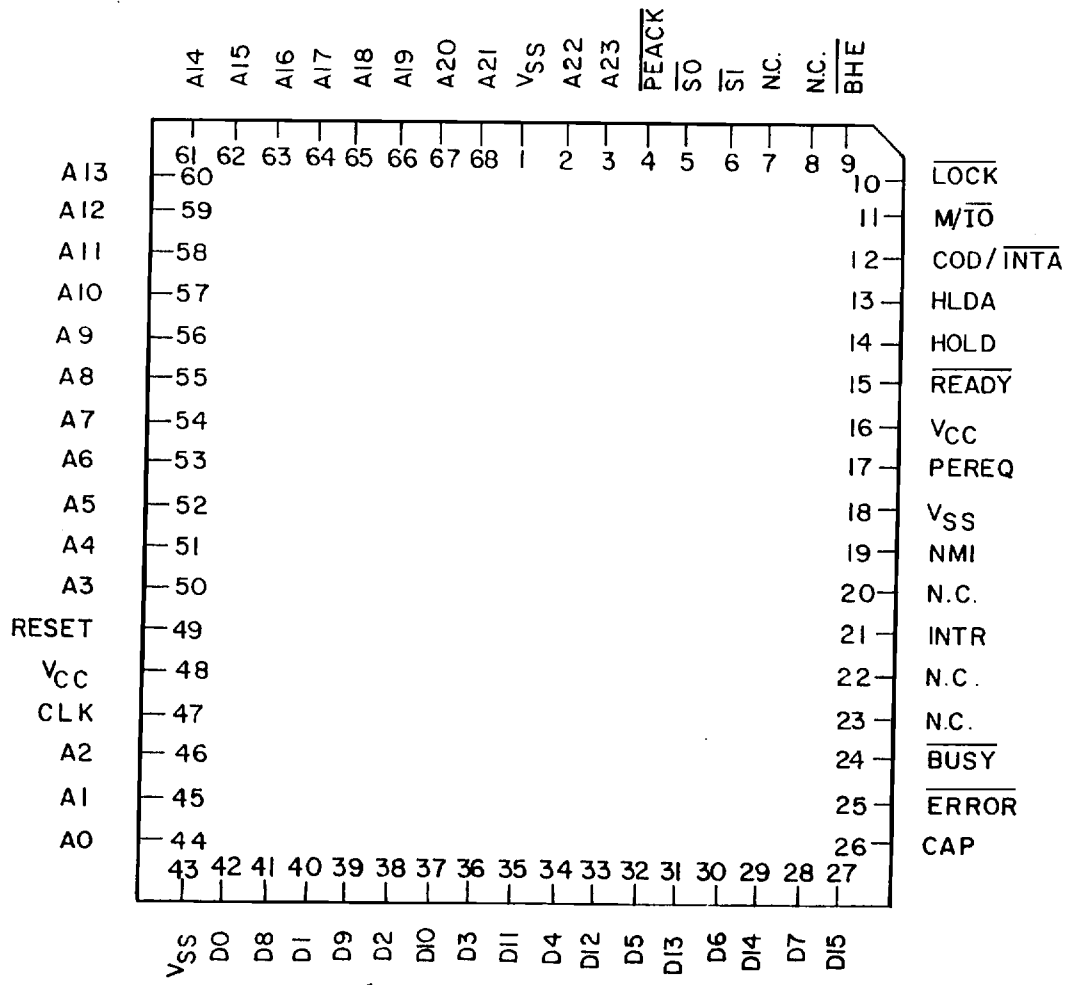


FIGURE 1. Terminal connections - Continued.

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE	CODE IDENT. NO.	DWG NO.
	A	67268	5962-85148
	REV	A	PAGE 9

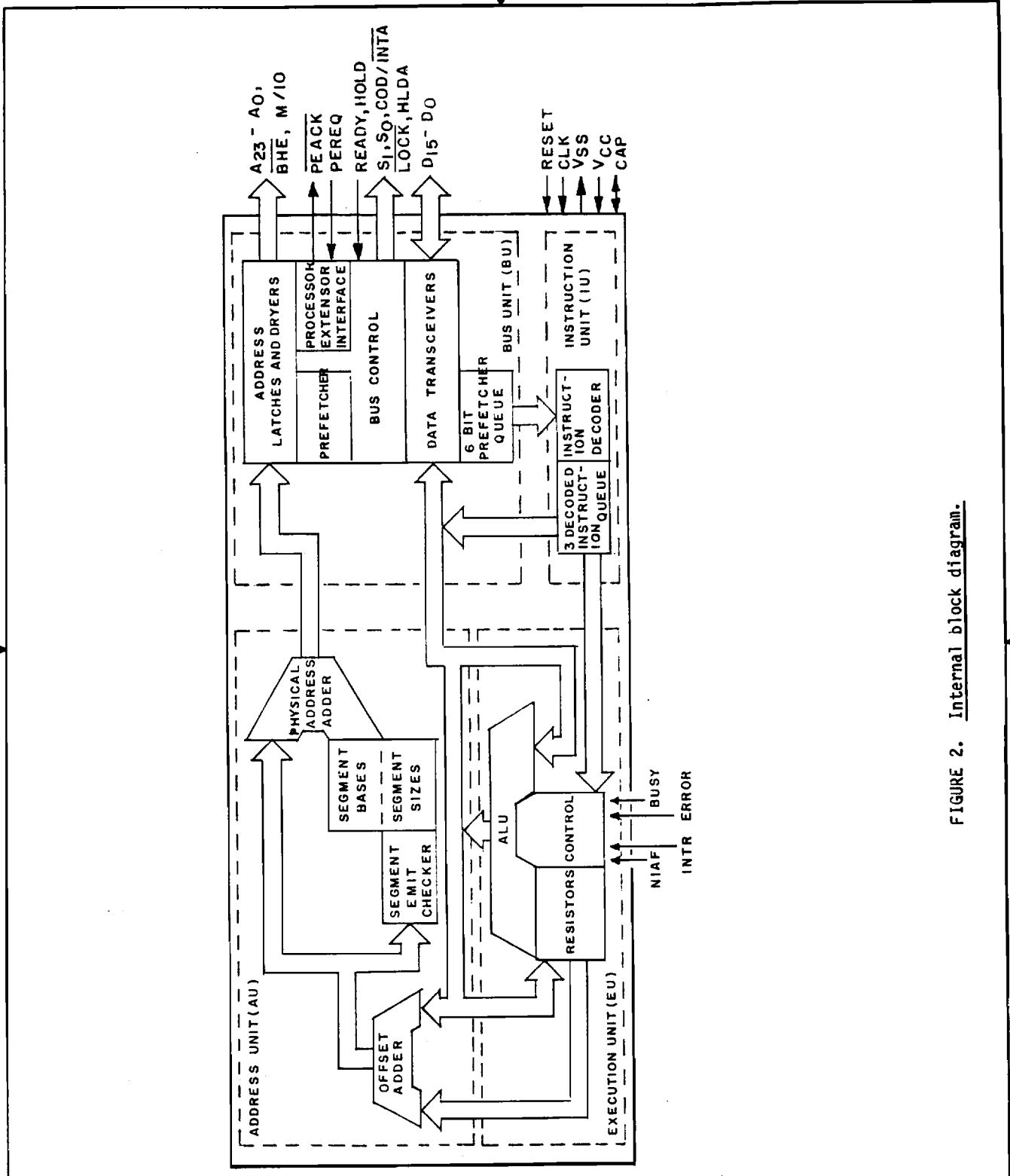


FIGURE 2. Internal block diagram.

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 67268	DWG NO. 5962-85148
		REV A	PAGE 10

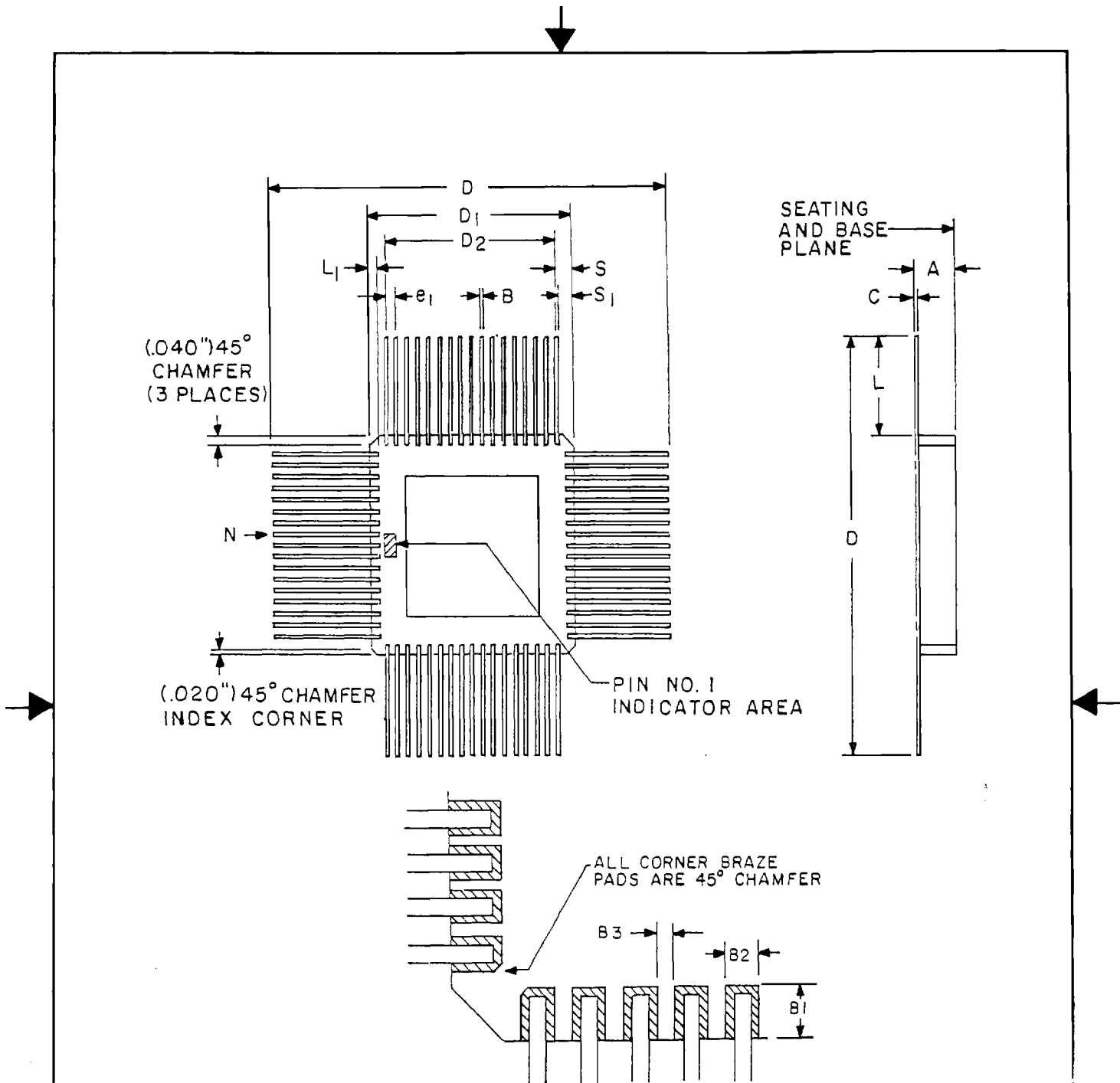


FIGURE 3. Case outline Y.

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 67268	DWG NO. 5962-85148
		REV A	PAGE 11

Symbol	Inches		Millimeters	
	Min	Max	Min	Max
A	0.080	0.106	2.03	2.69
B	0.016	0.020	0.41	0.51
B ₁	0.040	0.060	1.02	1.52
B ₂	0.030	0.040	0.76	1.02
B ₃	0.005	0.020	0.13	0.51
C	0.008	0.012	0.20	0.31
D	1.640	1.870	41.66	47.50
D ₁	0.935	0.970	23.75	24.64
D ₂	0.800 BSC		20.32 BSC	
e ₁	0.050 BSC		1.27 BSC	
L	0.375	0.450	9.53	11.43
L ₁	0.040	0.060	1.02	1.52
N	68		68	
S	0.066	0.087	1.68	2.21
S ₁	0.050		1.27	

FIGURE 3. Case outline Y - Continued.

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 67268	DWG NO. 5962-85148
		REV A	PAGE 12

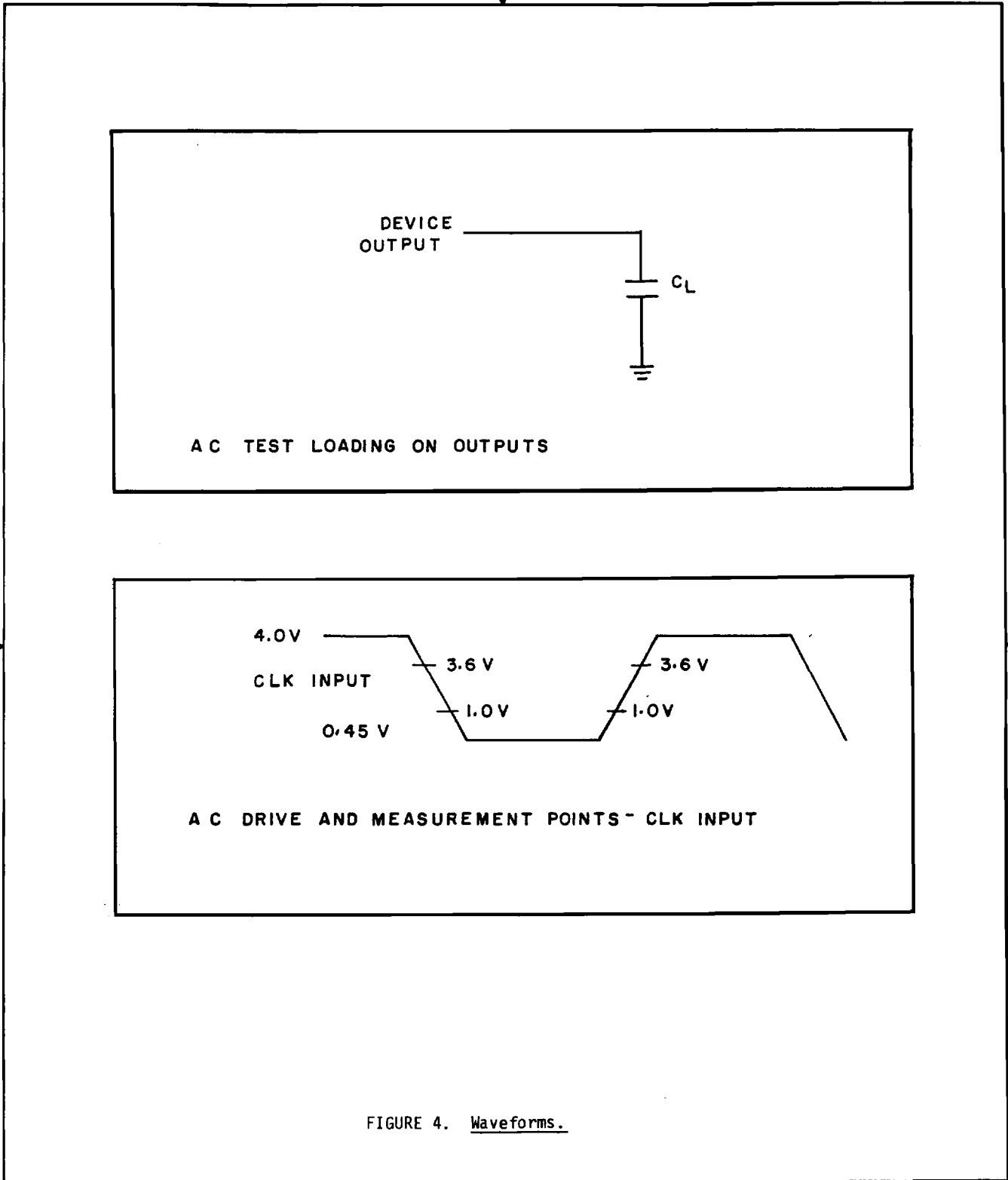


FIGURE 4. Waveforms.

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 67268	DWG NO. 5962-85148
		REV A	PAGE 13

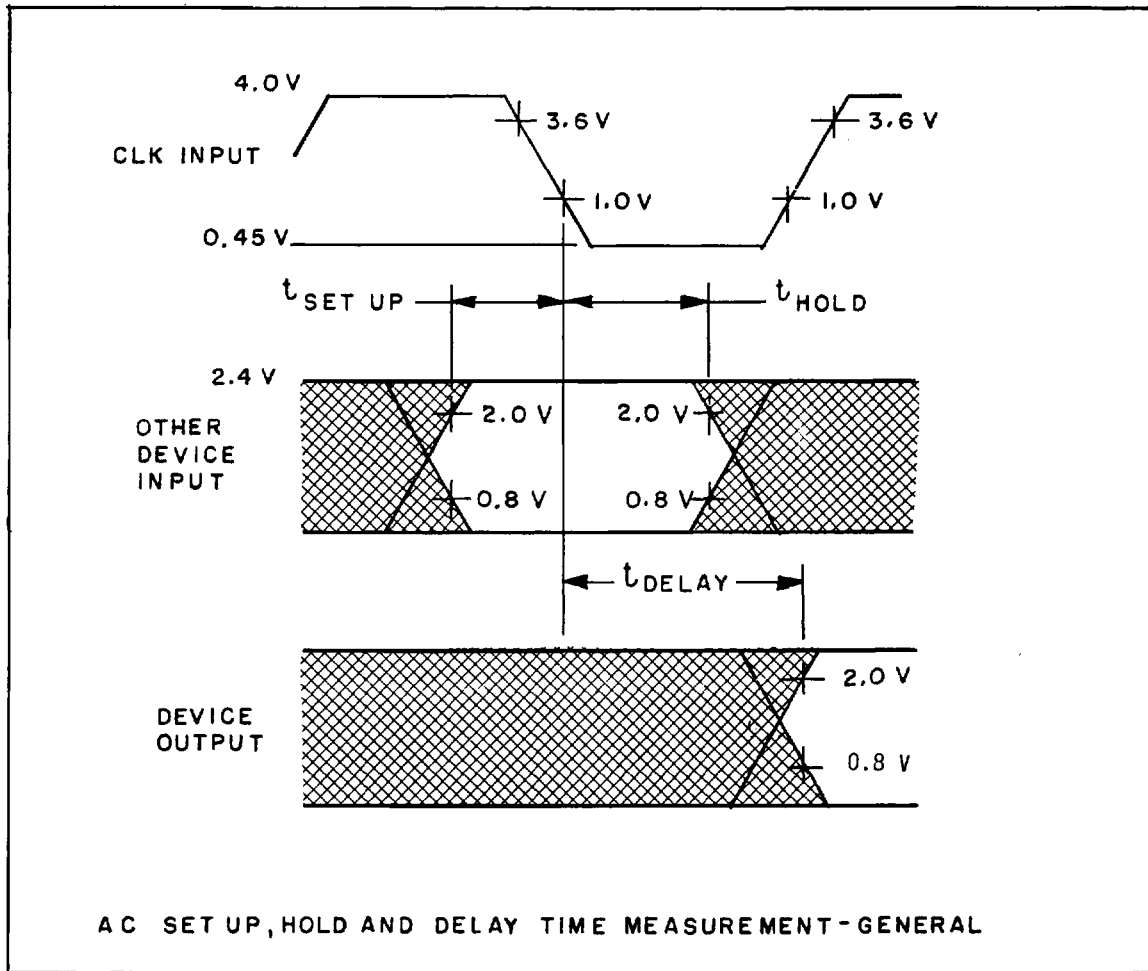


FIGURE 4. Waveforms - Continued.

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 67268	DWG NO. 5962-85148
		REV A	PAGE 14

Major cycle timing

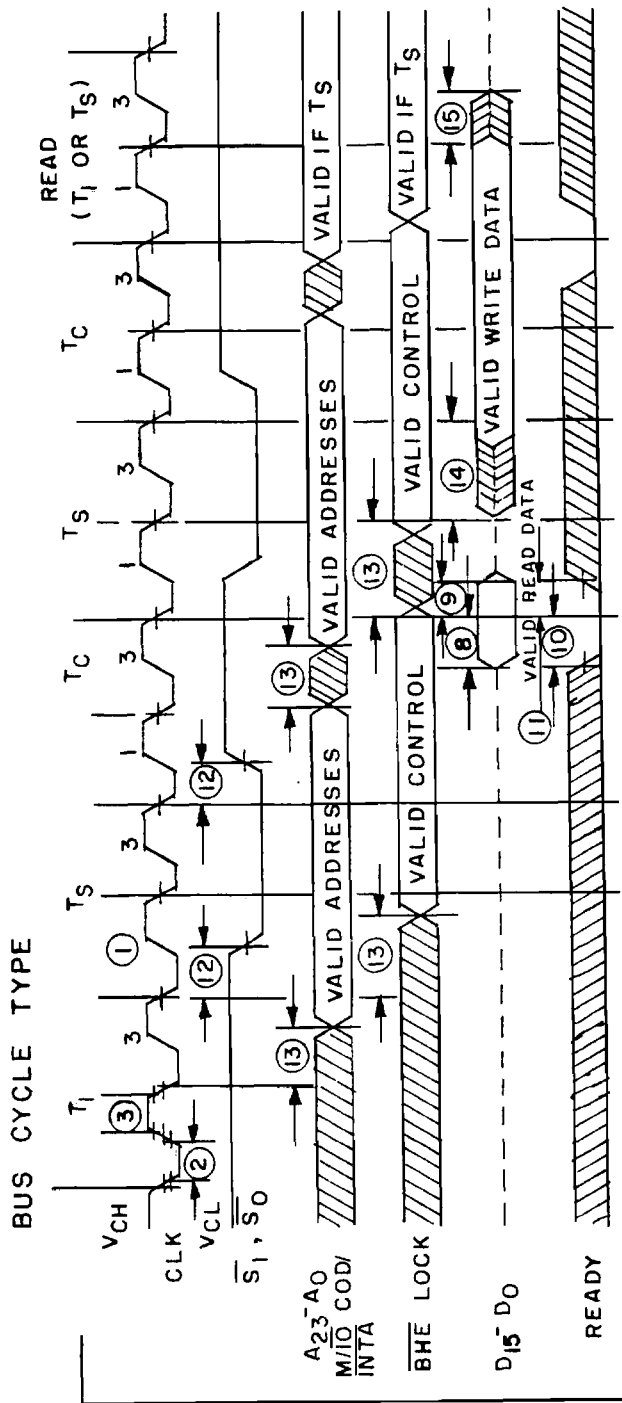


FIGURE 4. Waveforms - Continued.

MILITARY DRAWING

DEFENSE ELECTRONICS SUPPLY CENTER
DAYTON, OHIO

SIZE
A

CODE IDENT NO.
67268

DWG NO.

5962-85148

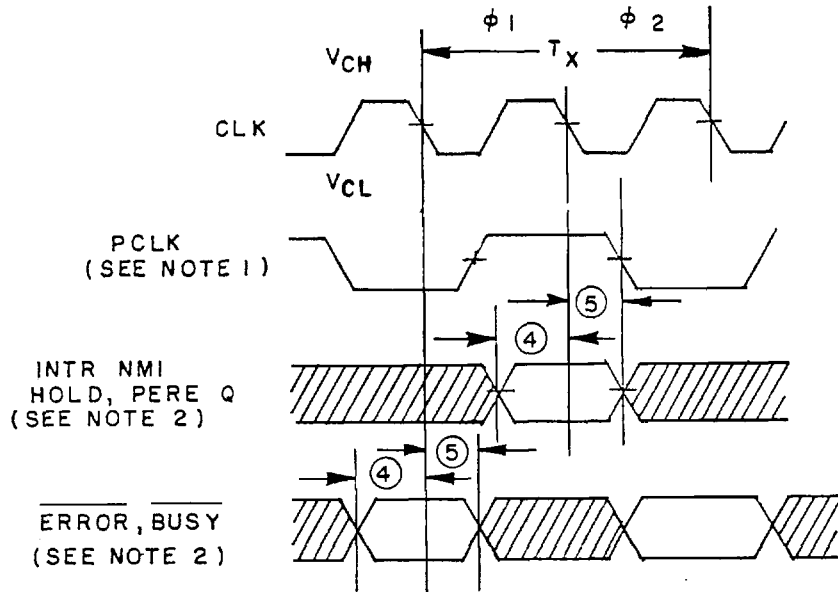
REV A

PAGE

15

Asynchronous input signal timing

BUS CYCLE TYPE



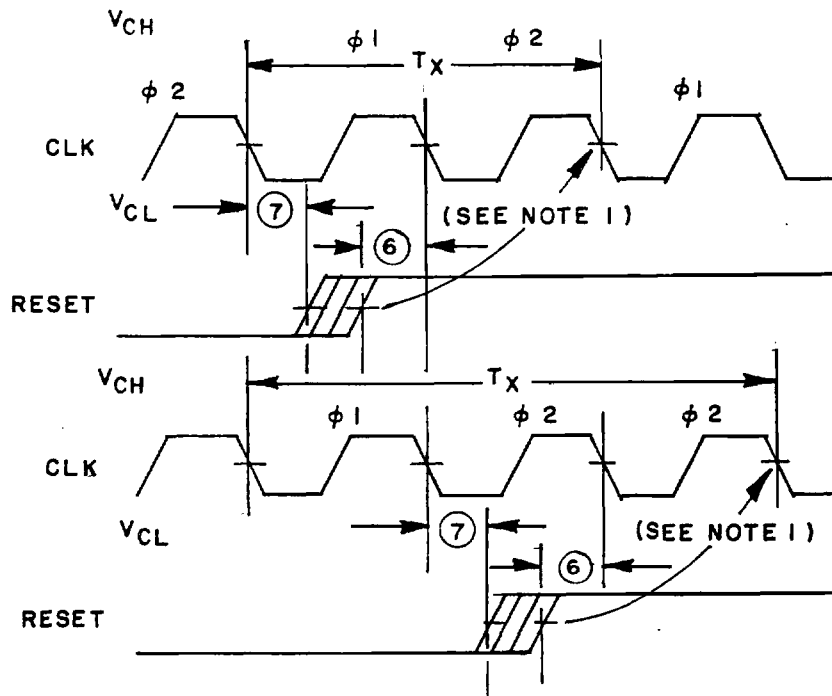
NOTES:

1. PCLK indicates which processor cycle phase will occur on the next CLK. PCLK may not indicate the correct phase until the first bus cycle is performed.
2. These inputs are asynchronous. The setup and hold times shown assure recognition for testing purposes.

FIGURE 4. Waveforms - Continued.

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 67268	DWG NO. 5962-85148
		REV A	PAGE 16

Reset input timing and subsequent processor cycle phase

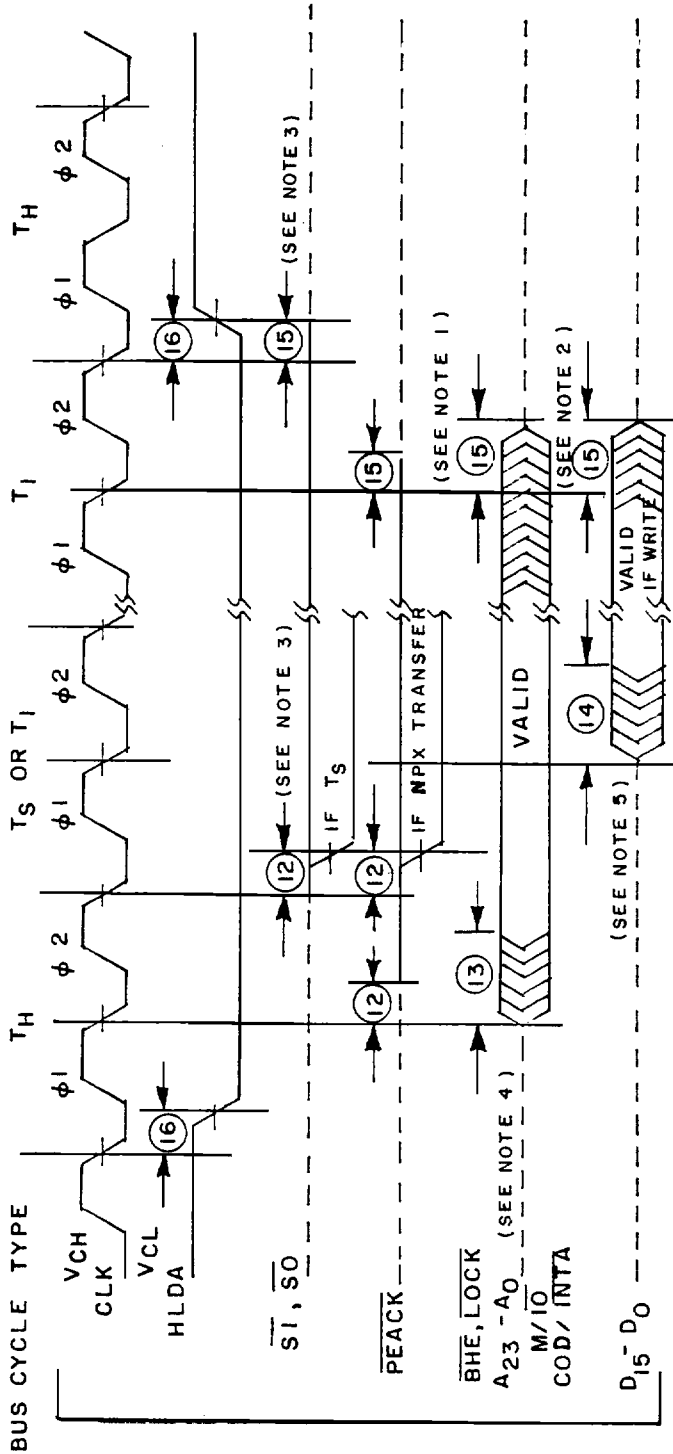


NOTE: When RESET meets the setup time shown, the next CLK will start or repeat $\phi 2$ of a processor cycle.

FIGURE 4. Waveforms - Continued.

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE	CODE IDENT. NO.	DWG NO.
	A	67268	5962-85148
	REV	A	PAGE 17

Exiting and entering hold



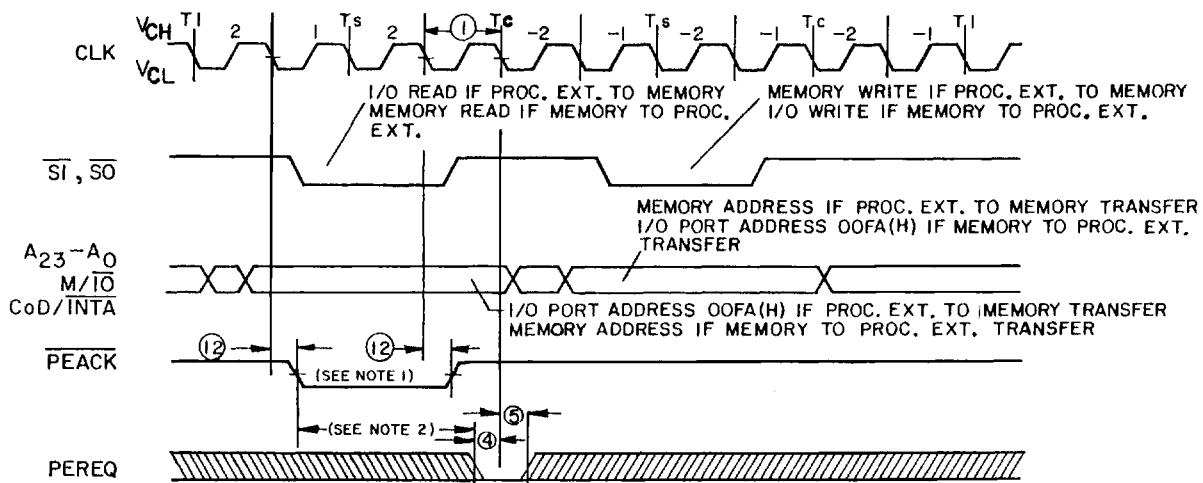
- NOTES:
1. These signals may not be driven by the device during the time shown. The worst case in terms of latest float time is shown.
 2. The data bus will be driven as shown if the last cycle before T_1 in the diagram was a write T_C .
 3. The M80286 floats its status pins during T_H . External 20 k Ω resistors keep these signals high.
 4. BHE and LOCK are driven at this time but will not become valid until T_S .
 5. The data bus will remain in three-state OFF if a read cycle is performed.

FIGURE 4. Waveforms - Continued.

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE	CODE IDENT. NO.	DWG NO.
	A	67268	5962-85148
	REV	A	PAGE 18

PEREQ/PEACK timing for one transfer only.

BUS CYCLE TYPE



Assuming word-aligned memory operand, if odd aligned, 80286 transfers to/from memory byte-at-a-time with two memory cycles.

NOTES:

1. PEACK always goes active during the first bus operation of a processor extension data operand and transfer sequence. The first bus operation will be either a memory read at operand address or I/O read at port address OoFA(H).
2. To prevent a second processor extension data operand transfer, the worst case maximum time (shown above) is: $3 \times \textcircled{1} - 11_{\text{MAX}} \textcircled{4}_{\text{MIN}}$. The actual configuration dependent, maximum time is: $3 \times \textcircled{1} - 11_{\text{MAX}} \textcircled{4}_{\text{MIN}} + A \times 2 \times \textcircled{1}$. A is the number of extra T_c states added to either the first or second bus operation of the processor extension data operand transfer sequence.

FIGURE 4. Waveforms - Continued.

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 67268	DWG NO. 5962-85148
		REV A	PAGE 19

Pin state during reset

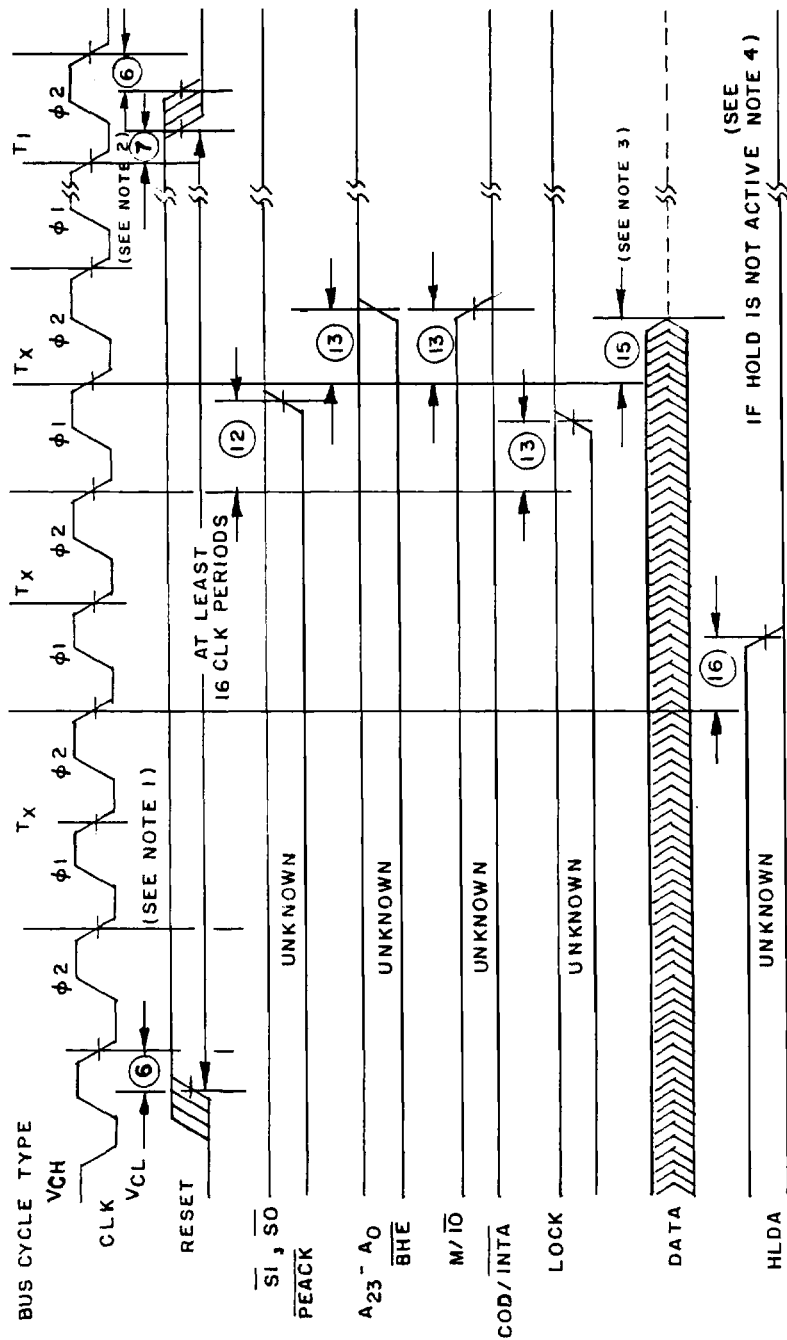


FIGURE 4. Waveforms - Continued.

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE	CODE IDENT. NO.	DWG NO.
	A	67268	5962-85148
	REV	A	PAGE 20



Pin state during reset

NOTES:

1. Setup time for RESET \uparrow may be violated with the consideration that $\phi 1$ of the processor clock may begin one system CLK period later.
2. Setup and hold times for RESET \downarrow must be met for proper operation, but RESET \downarrow may occur during $\phi 1$ or $\phi 2$.
3. The data bus is only guaranteed to be in three-state OFF at the time shown.
4. HOLD is acknowledged during RESET, causing HLDA to go active and the appropriate pins to float. If HOLD remains active while RESET goes inactive, the device remains in HOLD state and will not perform any bus accesses until HOLD is de-activated.



FIGURE 4. Waveforms - Continued.

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 67268	DWG NO. 5962-85148
		REV A	PAGE 21



3.5 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in 6.5. The certificate of compliance submitted to DESC-ECS prior to listing as an approved source of supply shall state that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.

3.6 Certificate of conformance. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.

3.7 Notification of change. Notification of change to DESC-ECS shall be required in accordance with MIL-STD-883 (see 3.1 herein).

3.8 Verification and review. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

4. QUALITY ASSURANCE PROVISIONS

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).

4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:

a. Burn-in test (method 1015 of MIL-STD-883).

(1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).

(2) $T_A = +125^\circ\text{C}$, minimum.

b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

4.3.1 Group A inspection.

a. Tests shall be as specified in table II herein.

b. Subgroups 5 and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.

c. Subgroup 4 (C_{IN} and C_O measurements) shall be measured only for the initial test and after process or design changes which may affect capacitance.

d. Subgroups 7 and 8 shall consist of verifying the instruction set.

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 67268	DWG NO. 5962-85148
		REV A	PAGE 22

4.3.2 Groups C and D inspections.

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test (method 1005 of MIL-STD-883) conditions:
 - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).
 - (2) $T_A = +125^\circ\text{C}$, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by appendix B of MIL-M-38510 and method 1005 of MIL-STD-883.

TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (per method 5005, table I)
Interim electrical parameters (method 5004)	---
Final electrical test parameters (method 5004)	1*, 2, 3, 7*, 8, 9, 10, 11
Group A test requirements (method 5005)	1, 2, 3, 4, 7, 8, 9, 10, 11
Groups C and D end-point electrical parameters (method 5005)	2, 8(125°C), 10
Additional electrical subgroups for group C periodic inspections	---

* PDA applies to subgroups 1 and 7.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item for all applications.

6.2 Replaceability. Replaceability is determined as follows:

- a. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
- b. When a QPL source is established, the part numbered device specified in this drawing will be replaced by the microcircuit identified as part number M38510/535--B--.

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 67268	DWG NO. 5962-85148
		REV A	PAGE 23

6.3 Comments. Comments on this drawing should be directed to DESC-ECS, Dayton, Ohio 45444, or telephone 513-296-5375.

6.4 Symbols, definitions, and functional descriptions. The symbols, definitions, and functional description for these devices shall be as follows:

Symbol	Type	Name and function										
PEREQ PEACK	I 0	Processor extension operand request and acknowledge extend the memory management and protection capabilities of the device to processor extensions. The PEREQ input requests the device to perform a data operand transfer for a processor extension. The PEACK output signals the processor extension when the requested operand is being transferred. PEREQ is active HIGH and floats to 3-state OFF during bus hold acknowledge. PEACK may be asynchronous to the system clock. PEACK is active LOW.										
BUSY ERROR	I I	Processor extension busy and error indicate the operating condition of a processor extension to the device. An active BUSY input stops device program execution on WAIT and some ESC instructions until BUSY becomes inactive (HIGH). The device may be interrupted while waiting for BUSY to become inactive. An active ERROR input causes the device to perform a processor extension interrupt when executing WAIT or some ESC instructions. These inputs are active LOW and may be asynchronous to the system clock.										
RESET	I	<p>System reset clears the internal logic of the device and is active HIGH. The device may be reinitialized at any time with a LOW to HIGH transition on RESET which remains active for more than 16 system clock cycles. During RESET active, the output pins of the device enter the state shown below:</p> <table border="1" data-bbox="669 1123 1428 1357"> <thead> <tr> <th colspan="2">Device pin state during reset</th> </tr> <tr> <th>Pin value</th> <th>Pin names</th> </tr> </thead> <tbody> <tr> <td>1 (HIGH)</td> <td>$\overline{S_0}, \overline{S_1}, \overline{PEACK}, A23-A0, \overline{BHE}, \overline{LOCK}$</td> </tr> <tr> <td>0 (LOW)</td> <td>$M/\overline{IO}, \overline{COD}/\overline{INTA}, \overline{HLDA}$</td> </tr> <tr> <td>3-state OFF</td> <td>$D_{15} - D_0$</td> </tr> </tbody> </table> <p>Operation of the device begins after a HIGH to LOW transition on RESET. The HIGH to LOW transition of RESET must be synchronous to the system clock. Approximately 50 system clock cycles are required by the device for internal initializations before the first bus cycle to fetch code from the power-on execution address is performed.</p> <p>A LOW to HIGH transition of RESET synchronous to the system clock will end a processor cycle at the second HIGH to LOW transition of the system clock. The LOW to HIGH transition of RESET may be asynchronous to the system clock; however, in this case it cannot be predetermined which phase of the processor clock will occur during the next system clock period. Synchronous LOW to HIGH transitions of RESET are required only for systems where the processor clock must be phase synchronous to another clock.</p>	Device pin state during reset		Pin value	Pin names	1 (HIGH)	$\overline{S_0}, \overline{S_1}, \overline{PEACK}, A23-A0, \overline{BHE}, \overline{LOCK}$	0 (LOW)	$M/\overline{IO}, \overline{COD}/\overline{INTA}, \overline{HLDA}$	3-state OFF	$D_{15} - D_0$
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MILITARY DRAWING

DEFENSE ELECTRONICS SUPPLY CENTER
DAYTON, OHIO

SIZE
A

CODE IDENT. NO.
67268

DWG NO.
5962-85148

REV A

PAGE 24

Symbol	Type	Name and function																																																																																										
V _{SS}	I	<u>System ground:</u> 0 volts.																																																																																										
V _{CC}	I	<u>System power:</u> +5 volt power supply																																																																																										
CAP	I	<u>Substrate filter capacitor:</u> a 0.047 μF ±20% 12 V capacitor must be connected between this pin and ground. This capacitor filters the output of the internal substrate bias generator. A maximum dc leakage current of 1 μA is allowed through the capacitor. For correct operation of the device, the substrate bias generator must charge this capacitor to its operating voltage. The capacitor chargeup time is 5 milliseconds (maximum) after V _{CC} and CLK reach their specified ac and dc parameters. RESET may be applied to prevent spurious activity by the CPU during this time. After this time, the device processor clock can be synchronized to another clock by pulsing RESET LOW synchronous to the system clock.																																																																																										
$\overline{S_1}, \overline{S_0}$	0	<p>Bus cycle status indicates initiation of a bus cycle and, along with M/I_O and COD/INTA, defines the type of bus cycle. The bus is in a T_S state whenever one or both are LOW, $\overline{S_1}$ and $\overline{S_0}$ are active LOW and float to 3-state OFF during bus hold acknowledge.</p> <table border="1" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th colspan="5">Bus cycle status definition</th> </tr> <tr> <th>COD/INTA</th> <th>M/I_O</th> <th>$\overline{S_1}$</th> <th>$\overline{S_0}$</th> <th>Bus cycle initiated</th> </tr> </thead> <tbody> <tr><td>0 (LOW)</td><td>0</td><td>0</td><td>0</td><td>Interrupt acknowledge</td></tr> <tr><td>0</td><td>0</td><td>0</td><td>1</td><td>Reserved</td></tr> <tr><td>0</td><td>0</td><td>1</td><td>0</td><td>Reserved</td></tr> <tr><td>0</td><td>0</td><td>1</td><td>1</td><td>None; not a status cycle</td></tr> <tr><td>0</td><td>1</td><td>0</td><td>0</td><td>IF A1 = 1 then halt; else shutdown</td></tr> <tr><td>0</td><td>1</td><td>0</td><td>1</td><td>Memory data read</td></tr> <tr><td>0</td><td>1</td><td>1</td><td>0</td><td>Memory data write</td></tr> <tr><td>0</td><td>1</td><td>1</td><td>1</td><td>None; not a status cycle</td></tr> <tr><td>1 (HIGH)</td><td>0</td><td>0</td><td>0</td><td>Reserved</td></tr> <tr><td>1</td><td>0</td><td>0</td><td>1</td><td>I/O read</td></tr> <tr><td>1</td><td>0</td><td>1</td><td>0</td><td>I/O write</td></tr> <tr><td>1</td><td>0</td><td>1</td><td>1</td><td>None; not a status cycle</td></tr> <tr><td>1</td><td>1</td><td>0</td><td>0</td><td>Reserved</td></tr> <tr><td>1</td><td>1</td><td>0</td><td>1</td><td>Memory instruction read</td></tr> <tr><td>1</td><td>1</td><td>1</td><td>0</td><td>Reserved</td></tr> <tr><td>1</td><td>1</td><td>1</td><td>1</td><td>None; not a status cycle</td></tr> </tbody> </table>	Bus cycle status definition					COD/INTA	M/I _O	$\overline{S_1}$	$\overline{S_0}$	Bus cycle initiated	0 (LOW)	0	0	0	Interrupt acknowledge	0	0	0	1	Reserved	0	0	1	0	Reserved	0	0	1	1	None; not a status cycle	0	1	0	0	IF A1 = 1 then halt; else shutdown	0	1	0	1	Memory data read	0	1	1	0	Memory data write	0	1	1	1	None; not a status cycle	1 (HIGH)	0	0	0	Reserved	1	0	0	1	I/O read	1	0	1	0	I/O write	1	0	1	1	None; not a status cycle	1	1	0	0	Reserved	1	1	0	1	Memory instruction read	1	1	1	0	Reserved	1	1	1	1	None; not a status cycle
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M/I _O	0	Memory I/O select distinguishes memory access from I/O access. If HIGH during T _S , a memory cycle or a halt/shutdown cycle is in progress. If LOW, an I/O cycle or an interrupt acknowledge cycle is in progress. M/I _O floats to 3-state OFF during bus hold acknowledge.																																																																																										

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 67268	DWG NO. 5962-85148
		REV A	PAGE 25

Symbol	Type	Name and function
COD/INTA	0	Code/interrupt acknowledge distinguishes instruction fetch cycles from memory data read cycles. Also distinguishes interrupt acknowledge cycles from I/O cycles. COD/INTA floats to 3-state OFF during bus hold acknowledge. Its timing is the same as M/I \bar{O} .
LOCK	0	Bus lock indicates that other system bus masters are not to gain control of the system bus following the current bus cycle. The LOCK signal may be activated explicitly by the "LOCK" instruction prefix or automatically by device hardware during memory XCHG instructions, interrupt acknowledge, or descriptor table access. LOCK is active LOW and floats to 3-state OFF during bus hold acknowledge.
READY	I	Bus ready terminates a bus cycle. Bus cycles are extended without limit until terminated by READY LOW, READY is an active LOW synchronous input requiring setup and hold times relative to the system clock be met for correct operation. READY is ignored during bus hold acknowledge.
HOLD HLDA	I 0	Bus hold request and hold acknowledge control ownership of the device local bus. The HOLD input allows another local bus master to request control of the local bus. When control is granted, the device will float its bus drives to 3-state OFF and then activate HLDA, thus entering the bus hold acknowledge condition. The local bus will remain granted to the requesting master until HOLD becomes inactive which results in the device deactivating HLDA and regaining control of the local bus. This terminates the bus hold acknowledge condition. HOLD may be synchronous to the system clock. These signals are active HIGH.
INTR	I	Interrupt request requests the device to suspend its current program execution and service a pending external request. Interrupt requests are masked whenever the interrupt enable bit in the flag word is cleared. When the device responds to an interrupt request, it performs two interrupt acknowledge bus cycles to read an 8-bit interrupt vector that identifies the source of the interrupt. To assure program interruption, INTR must remain active until the first interrupt acknowledge cycle is completed. INTR is sampled at the beginning of each processor cycle and must be active HIGH at least two processor cycles before the current instruction ends in order to interrupt before the next instruction. INTR is level sensitive, active HIGH, and may be asynchronous to the system clock.

MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 67268	DWG NO. 5962-85148
		REV A	PAGE 26

Symbol	Type	Name and function																		
NMI	I	Non-maskable interrupt request interrupts the device with an internally supplied vector value of 2. No interrupt acknowledge cycles are performed. The interrupt enable bit in the device flag word does not affect this input. The NMI input is active HIGH, may be asynchronous to the system clock, and is edge triggered after internal synchronization. For proper recognition, the input must have been previously LOW for at least four system clock cycles and remain HIGH for at least four system clock cycles.																		
CLK	I	System clock provides the fundamental timing for multi-tasking systems. It is divided by two inside the device to generate the processor clock. The internal divided-by-two circuitry can be synchronized to an external clock generator by a LOW to HIGH transition on the RESET input.																		
D ₁₅ - D ₀	I/O	Data bus inputs data during memory, I/O, and interrupt acknowledge read cycles; outputs data during memory and I/O write cycles. The data bus is active HIGH and floats to 3-state OFF during bus hold acknowledge.																		
A ₂₃ - A ₀	0	Address bus outputs physical memory and I/O port addresses. A ₀ is LOW when data is to be transferred on pins D ₇ -D ₀ . A ₂₃ -A ₁₆ are LOW during I/O transfers. The address bus is active HIGH and floats to 3-state OFF during bus hold acknowledge.																		
$\overline{\text{BHE}}$	0	<p>Bus high enable indicates transfer of data on the upper byte of the data bus, D₁₅-D₈. Eight-bit oriented devices assigned to the upper byte of the data bus would normally use $\overline{\text{BHE}}$ to condition chip select functions. $\overline{\text{BHE}}$ is active LOW and floats to 3-state OFF during bus hold acknowledge.</p> <table border="1" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th colspan="3">$\overline{\text{BHE}}$ and A₀ encodings</th> </tr> <tr> <th>$\overline{\text{BHE}}$ value</th> <th>A₀ value</th> <th>Function</th> </tr> </thead> <tbody> <tr> <td>0</td> <td>0</td> <td>Word transfer</td> </tr> <tr> <td>0</td> <td>1</td> <td>Byte transfer on upper half of data bus (D₁₅-D₈)</td> </tr> <tr> <td>1</td> <td>0</td> <td>Byte transfer on lower half of data bus (D₇-D₀)</td> </tr> <tr> <td>1</td> <td>1</td> <td>Reserved</td> </tr> </tbody> </table>	$\overline{\text{BHE}}$ and A ₀ encodings			$\overline{\text{BHE}}$ value	A ₀ value	Function	0	0	Word transfer	0	1	Byte transfer on upper half of data bus (D ₁₅ -D ₈)	1	0	Byte transfer on lower half of data bus (D ₇ -D ₀)	1	1	Reserved
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MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 67268	DWG NO 5962-85148
		REV A	PAGE 27

6.5 Approved source of supply. An approved source of supply is listed herein. Additional sources will be added as they become available. The vendor listed herein has agreed to this drawing and a certificate of compliance (see 3.5) has been submitted to DESC-ECS.

Military drawing part number	Vendor CAGE number	Vendor similar part number <u>1/</u>	Replacement military specification part number
5962-8514801XX 5962-8514801YX	34649 34649	MG80286-8/B MQ80286-8/B	M38510/53502BXX M38510/53502BYX
5962-8514802XX 5962-8514802YX	34649 34649	MG80286-6/B MQ80286-6/B	M38510/53501BXX M38510/53501BYX
5962-8514803XX 5962-8514803YX	34649 34649	MG80286-10/B MQ80286-10/B	--- ---

1/ Caution: Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE number

34649

Vendor name and address

Intel Corporation
5000 W. Williams Field Road
Chandler, AZ 85224

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MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO	SIZE A	CODE IDENT. NO. 67268	DWG NO. 5962-85148
		REV A	PAGE 28